4.5Ω 300MHz Bandwidth Dual SPDT Analog Switch UM4717 CSP10 1.90×1.40 UM4717O WOFN-10 1.80×1.40

General Description

The UM4717/UM4717Q low-voltage, low on-resistance (R_{ON}), dual single-pole/double-throw (SPDT) analog switch operates from a single +1.8V to +5.5V supply. The device is designed for USB 1.1/2.0 and audio switching applications.

The UM4717/UM4717Q features two 4.5 Ω R_{ON} (max) SPDT switches with 1.2 Ω flatness and 0.3 Ω matching between channels. The switch offers break-before-make switching (1ns) with t_{ON} < 80ns and t_{OFF} < 40ns at +2.7V. The digital logic inputs are +1.8V logic compatible with a +2.7V to +3.6V supply.

The UM4717 is packaged in a chip-scale package (CSP), occupies only a 1.90mm ×1.40mm area and has a 4×3 bump array with a bump pitch of 0.50mm. The UM4717Q is packaged in a 1.80mm ×1.40mm WQFN-10 package, both significantly reducing the required PC board area.

Applications

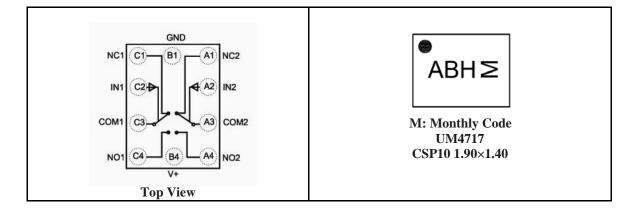
- USB 1.1/2.0 Signal Switching Circuits
- Battery-Operated Equipment
- Audio/Video-Signal Routing
- Headphone Switching
- Low-Voltage Data-Acquisition Systems
- Sample-and-Hold Circuits
- Cell Phones
- PDAs

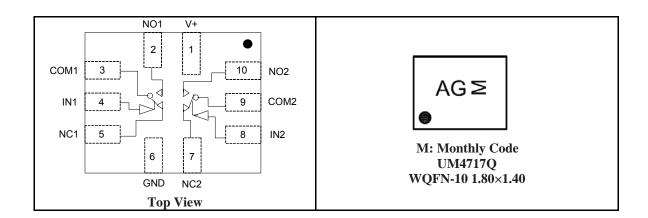
Features

- 2ns (max) Differential Skew
- -3dB Bandwidth: 300MHz
- Low 15pF On-Channel Capacitance
- Single-Supply Operation from +1.8V to +5.5V
- 4.5Ω R_{ON} (max) Switches
 0.3Ω (max) R_{ON} Match (+3.0V Supply)
 1.2Ω (max) Flatness (+3.0V Supply)
- Rail-to-Rail Signal Handling
- High Off-Isolation: -55dB (10MHz)
- Low Crosstalk: -80dB (10MHz)
- Low Distortion: 0.03%
- +1.8V CMOS-Logic Compatible
- < 0.5nA Leakage Current at +25°C

Pin Configurations

Top View





Pin Description

F	Pin		Function
UM4717	UM4717Q	Name	Tunction
A1	7	NC2	Analog Switch 2-Normally Closed Terminal
A2	8	IN2	Analog Switch 2-Digital Control Input
A3	9	COM2	Analog Switch 2 –Common Terminal
A4	10	NO2	Analog Switch 2-Normally Open Terminal
B1	6	GND	Ground Connection
B4	1	V_{+}	Positive Supply Voltage
C1	5	NC1	Analog Switch 1-Normally Closed Terminal
C2	4	IN1	Analog Switch 1-Digital Control Input
С3	3	COM1	Analog Switch 1 –Common Terminal
C4	2	NO1	Analog Switch 1-Normally Open Terminal

Ordering Information

Part Number	Packaging Type	Marking Code	Shipping Qty
UM4717	CSP10 1.90×1.40	ABH	3000pcs/7 Inch Tape & Reel
UM4717Q	WQFN-10 1.80×1.40	AG	3000pcs/7 Inch Tape & Reel

Function Table

IN_	NO_	NC_
0	OFF	ON
1	ON	OFF

Absolute Maximum Ratings

Symbol	Para	meter	Limit	Unit
V_{+}	Supply Voltage		-0.3 to $+6.0$	
V_{S}	DC Switch Voltage (Note)	1)	-0.3 to $(V_+ + 0.3)$	V
IN_	DC IN Voltage		-0.3 to $+6.0$	
Io	Continuous Current (COM	I_, NO_, NC_)	±100	mA
Ip	Peak Current (Pulsed at 1r	ns, 10% duty cycle)	±200	ША
To	Operating Temperature Ra	inge	- 40 to +85	
$T_{ m J}$	Junction Temperature		+150	
T_{STG}	Storage Temperature Rang	ge	- 65 to +150	
$T_{ m L}$	Junction Lead Temperatur	e (Soldering, 10seconds)	+300	°C
Т	Bump Temperature	Infrared (15s)	+220	
T_{Bump}	(Soldering)	+215		
P_{D}	Continuous Power Dissipa	909	mW	
ESD	ESD Method 3015.7		>2000	V

Note1: Signals on COM_, NO_, or NC_ exceeding V_+ or GND are clamped by internal diodes. Limit forward-diode current to maximum current rating.

Electrical Characteristics (Single +3V Supply)

 $(V_+=+2.7V \text{ to } +3.6V, V_{IH}=+1.4V, V_{IL}=+0.5V, T_A=T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } V_+=+3.0V, T_A=+25^{\circ}C) \text{ (Notes 2,3)}$

G 1.1	Domomoton	T 4 C 111		Limits (-40 to 85 °C)			T T *4
Symbol	Parameter	Test Conditions	Temp	Min	Тур	Max	Unit
DC Electri	cal Characteristics						
$egin{array}{c} V_{COM_} \ V_{NO_} \ V_{NC} \end{array}$	Analog Signal Range		Full	0		V_{+}	V
V_{+}	Power Supply Range		Full	1.8		5.5	V
I_+	Supply Current	V_{+} =+5.5V, $V_{IN_{-}}$ =0V or V_{+}	Full			1	μA
I _{COM_(ON)}	COM_On Leakage Current (Note7)	V_{+} = +3.6V, $V_{COM_{-}}$ =0.3V, 3.3V; $V_{NO_{-}}$ or $V_{NC_{-}}$ = 0.3V, 3.3V, or floating	Room Full	-1 -2	+0.01	+1 +2	nA
I_{OFF}	OFF State Leakage Current (Note7)	$V_{+} = +3.6V, V_{COM} = 0.3V, 3.3V;$ V_{NO} or $V_{NC} = 3.3V, 0.3V$	Room Full	-0.5 -1	+0.01	+0.5 +1	nA
V_{IH}	Input High Voltage		Full	1.4			V
$V_{\rm IL}$	Input Low Voltage		Full			0.5	V
$I_{\rm IN}$	Input Leakage Current	$V_{+} = +3.6V$, $V_{IN_{-}} = 0$ or 5.5V	Full	-100		+100	nA
D	On Registering (Noted)	$V_{+} = +2.7V$, $I_{COM} = 10mA$;	Room		3.0	4.5	Ω
R_{ON}	On-Resistance (Note4)	V_{NO} or $V_{NC} = 1.5V$	Full			5	
ΔR_{ON}	On Resistance Match Between Channels	$V_{+} = +2.7V, I_{COM} = 10mA;$	Room		0.1	0.3	Ω
ZIXON	(Notes 4,5)	$V_{NO_{\perp}}$ or $V_{NC_{\perp}} = 1.5V$	Full			0.4	32
R_{FLAT}	On Resistance Flatness	$V_{+} = +2.7V$, $I_{COM} = 10mA$;	Room		0.6	1.2	Ω
	(Note6)	$V_{NO_{\perp}}$ or $V_{NC_{\perp}} = 1.0V$, 1.5V, 2.0V	Full			1.5	



Electrical Characteristics (Single +3V Supply)(Continued)

 $(V_+=+2.7V \text{ to } +3.6V, V_{IH}=+1.4V, V_{IL}=+0.5V, T_A=T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } V_+=+3.0V, T_A=+25^{\circ}C) \text{ (Notes 2,3)}$

Crombal	Parameter	Test Conditions	Toman	Limits (-40 to 85 °C)			Unit
Symbol	Parameter	Test Conditions	Temp	Min	Тур	Max	Oint
AC Electric	eal Characteristics						
$t_{ m ON}$	Turn-On Time	V_{NO} , V_{NC} =1.5V; R_L =300 Ω , C_L =35pF, Figure1; V_{1H} =1.5V, V_{1L} =0V	Room Full		40	80 100	ns
$t_{ m OFF}$	Turn-Off Time	V_{NO} , V_{NC} = 1.5V; R_L =300 Ω , C_L =35pF, Figure1; V_{1H} =1.5V, V_{1L} =0V	Room Full		20	40 50	ns
$t_{ m BBM}$	Break Before Make Time (Note7)	$V_{NO_}$, $V_{NC_}$ =1.5V; R_L =300 Ω , C_L =35pF, Figure2	Room Full	1	8		ns
t_{SKEW}	Skew (Note7)	R_S =39 Ω , C_L =50pF, Figure3	Full		0.15	2	ns
$Q_{\rm INJ}$	Charge Injection	$C_L = 1.0 \text{ nF}, \text{ Figure 4}$ $V_{GEN} = 1.5 \text{V}, R_{GEN} = 0 \Omega$	Room		5		рC
V _{ISO}	Off Isolation	$f = 10 \text{ MHz}$; $V_{NO_}$, $V_{NC_} = 1V_{P-P}$; $R_L = 50\Omega$, $C_L = 5pF$, Figure 5	Room		-55		dB
* ISO	On isolation	$f = 1 \text{ MHz}$; V_{NO} , $V_{NC} = 1V_{P-P}$; $R_L = 50\Omega$, $C_L = 5pF$, Figure 5	Room		-80		ui)
V_{CT}	Crosstalk (Note8)	$f = 10 \text{ MHz}; V_{NO_}, V_{NC_} = 1V_{P-P};$ $R_L = 50\Omega, C_L = 5pF, Figure 5$	Room		-80		dB
V CT	Crosstaik (Notes)	$f = 1 \text{ MHz}$; V_{NO} , $V_{NC} = 1V_{P-P}$; $R_L = 50\Omega$, $C_L = 5pF$, Figure 5	Koom		-110		ub
BW	-3 dB Bandwidth	Signal=0dBm, R_L =50 Ω , C_L =5pF, Figure5	Room		300		MHz
THD	Total Harmonic Distortion	$\begin{array}{c} R_L = 600\Omega \\ V_{COM} = 2V_{P-P} \end{array}$	Room		0.03		%
Capacitanc	e						
$C_{NO_(OFF)}$ $C_{NC_(OFF)}$	NO_, NC_ Off Capacitance	f=1MHz, Figure 6	Room		9		pF
$C_{(ON)}$	Switch On Capacitance	f=1MHz, Figure 6	Room		15		pF



Electrical Characteristics (Single +5V Supply)

 $(V_+=+4.2V \text{ to } +5.5V, V_{IH}=+2.0V, V_{IL}=+0.8V, T_A=T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } V_+=+5.0V, T_A=+25^{\circ}C) \text{ (Notes 2,3)}$

Crombal	Parameter	Test Conditions	Tomm	Limits (-40 to 85 °C)			TT .4
Symbol	rarameter	Test Conditions	Temp	Min	Тур	Max	Unit
DC Electri	cal Characteristics						
$egin{array}{c} V_{COM_} \ V_{NO_} \ V_{NC} \end{array}$	Analog Signal Range		Full	0		V_{\pm}	V
V_{\pm}	Power Supply Range		Full	1.8		5.5	V
I_{+}	Supply Current	$V_{+} = +5.5V$, $V_{IN_{-}} = 0V$ or V_{+}	Full			1	μA
I _{COM_(ON)}	COM_On Leakage Current (Note7)	V_{+} = +5.5V, $V_{COM_{-}}$ = 1.0V, 4.5V; $V_{NO_{-}}$ or $V_{NC_{-}}$ = 1.0V, 4.5V, or floating	Room Full	-1 -2	+0.01	+1 +2	nA
I_{OFF}	OFF State Leakage Current (Note7)	$V_{+} = +5.5V, V_{COM} = 1.0V, 4.5V;$ V_{NO} or $V_{NC} = 1.0V, 4.5V$	Room Full	-0.5 -1	+0.01	+0.5 +1	nA
V_{IH}	Input High Voltage		Full	2.0			V
$V_{\rm IL}$	Input Low Voltage		Full			0.8	V
$I_{\rm IN}$	Input Leakage Current	$V_{+} = +5.5V$, $V_{IN} = 0$ or V_{+}	Full	-100		+100	nA
n	O. P. id. Old A)	$V_{+} = +4.2V, I_{COM} = 10mA;$	Room		1.7	3	Ω
R_{ON}	On-Resistance (Note4)	$V_{NO_{\perp}}$ or $V_{NC_{\perp}} = 3.5V$	Full			3.5	
ΔR_{ON}	On Resistance Match Between Channels	$V_{+} = +4.2V, I_{COM} = 10mA;$	Room		0.1	0.3	Ω
ΔIXON	(Notes 4,5)	$V_{NO_{\perp}}$ or $V_{NC_{\perp}} = 3.5 V$	Full			0.4	32
R_{FLAT}	On Resistance Flatness	$V_{+} = +4.2V, I_{COM} = 10mA;$	Room		0.4	1.2	Ω
**FLAI	(Note6)	$V_{NO_{-}}$ or $V_{NC_{-}} = 1.0V, 2.0V, 3.5V$	Full			1.5]

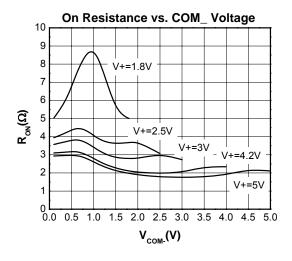
Electrical Characteristics (Single +5V Supply)(Continued)

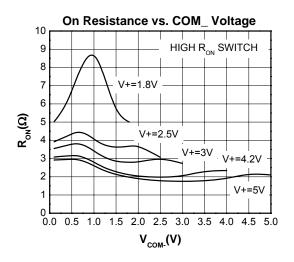
 $(V_+=+4.2V$ to +5.5V, $V_{IH}=+2.0V$, $V_{IL}=+0.8V$, $T_A=T_{MIN}$ to T_{MAX} , unless otherwise noted. Typical values are at $V_+=+5.0V$, $T_A=+25$ °C) (Notes 2,3)

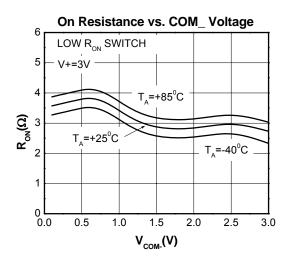
6 1 1	Parameter	T 4 C 1141	TD.	Limits (-40 to 85 °C)			TT 14
Symbol	Parameter	Test Conditions	Temp	Min	Тур	Max	Unit
AC Electric	cal Characteristics						
t_{ON}	Turn-On Time	$V_{NO_{-}}, V_{NC_{-}}=3.0V;$ $R_{L}=300\Omega, C_{L}=35pF, Figure1;$	Room Full		30	80 100	ns
t_{OFF}	Turn-Off Time	V_{NO} , V_{NC} =3.0V; R_L =300 Ω , C_L =35pF, Figure1;	Room Full		20	40 50	ns
t_{BBM}	Break Before Make Time (Note7)	$V_{NO_}$, $V_{NC_}$ =3.0V; R_L =300 Ω , C_L =35pF, Figure2	Room Full	1	8		ns
$t_{\rm SKEW}$	Skew (Note7)	R_S =39 Ω , C_L =50pF, Figure3	Full		0.15	2	ns
$Q_{\rm INJ}$	Charge Injection	$C_L = 1.0 \text{ nF}, \text{ Figure 4}$ $V_{GEN} = 1.5 \text{ V}, R_{GEN} = 0 \Omega$	Room		9		рC
3.7	OWI 14	$f = 10 \text{ MHz}; V_{NO_}, V_{NC_} = 1V_{P-P};$ $R_L = 50\Omega, C_L = 5pF, Figure 5$	n		-55		dB
$V_{\rm ISO}$	Off Isolation	$f = 1 \text{ MHz}$; V_{NO} , $V_{NC} = 1V_{P-P}$; $R_L = 50\Omega$, $C_L = 5pF$, Figure 5	Room		-80		ав
W	Consiste III (Note 9)	$f = 10 \text{ MHz}; V_{NO_}, V_{NC_} = 1V_{P-P};$ $R_L = 50\Omega, C_L = 5pF, Figure 5$	Room		-80		dB
V_{CT}	Crosstalk (Note8)	$f = 1 \text{ MHz}; V_{NO}, V_{NC} = 1V_{P-P};$ $R_L = 50\Omega, C_L = 5pF, Figure 5$	Koom		-110		ав
BW	-3 dB Bandwidth	Signal=0dBm, R_L =50 Ω , C_L =5pF, Figure5	Room		300		MHz
THD	Total Harmonic Distortion	R_L =600 Ω V_{COM} =2 V_{P-P}	Room		0.03		%
Capacitanc	e						
C _{NO_(OFF)} C _{NC (OFF)}	NO_, NC_ Off Capacitance	f=1MHz, Figure 6	Room		9		pF
$C_{(ON)}$	Switch On Capacitance	f=1MHz, Figure 6	Room		15		pF

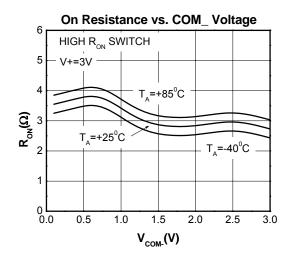
- Note 2: The parts are 100% tested at +25°C only, and guaranteed by design over the specified temperature range.
- Note 3: The algebraic convention used in this data sheet is where the most negative value is a minimum and the most positive value is a maximum.
- Note 4: Guaranteed by design.
- Note 5: $\Delta R_{ON} = R_{ON(MAX)} R_{ON(MIN)}$.
- Note 6: Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal ranges.
- Note 7: Guaranteed by design.
- Note 8: Between any two switches.

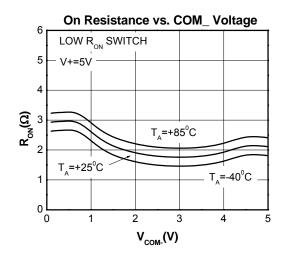
Typical Operating Characteristics

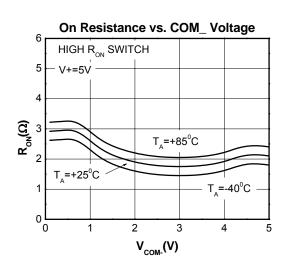




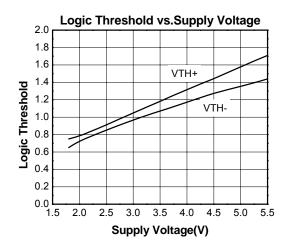


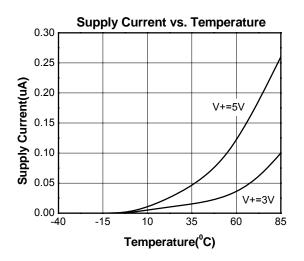


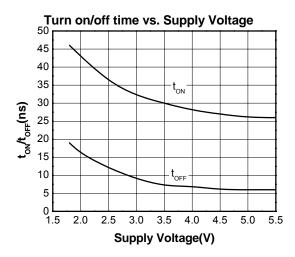


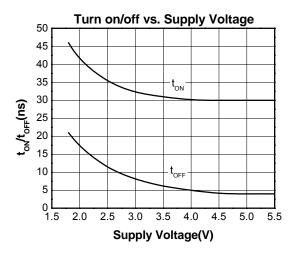


Typical Operating Characteristics

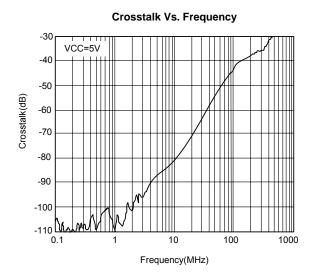


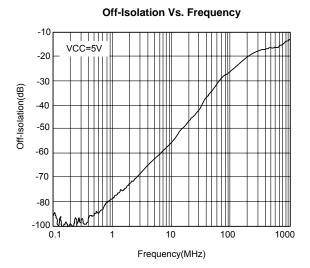


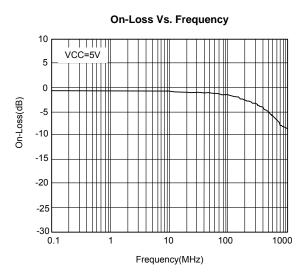




Typical Operating Characteristics









Detailed Description

The UM4717/UM4717Q high-speed, low-voltage, low on-resistance (R_{ON}), dual SPDT analog switch operates from a single +1.8V to +5.5V supply. The switch features break-before-make switching operation and fast switching speeds (t_{ON} = 80ns (max), t_{OFF} = 40ns (max)).

These switch has low 15pF on-channel capacitance, which allows for 12Mbps switching of the data signals for USB 1.0/1.1 applications. The UM4717/UM4717Q is designed to switch D_+ and D_- USB signals with a guaranteed skew of less than 2ns (see Figure 4) as measured from 50% of the input signal to 50% of the output signal.

Applications Information

Digital Control Inputs

The UM4717/UM4717Q logic inputs accept up to +5.5V regardless of supply voltage. For example, with a +3.3V supply, IN_ can be driven low to GND and high to +5.5V allowing for mixing of logic levels in a system. Driving the control logic inputs rail-to-rail minimizes power consumption. For a +3V supply voltage, the logic thresholds are 0.5V (low) and 1.4V (high); for a +5V supply voltage, the logic thresholds are 0.8V (low) and 2.0V (high).

Analog Signal Levels

The on-resistance of the UM4717/UM4717Q changes very little for analog input signals across the entire supply voltage range (see the Typical Operating Characteristics). The switches are bidirectional, so the NO_, NC_, and COM_ pins can be either inputs or outputs.

Power-Supply Sequencing and Over-voltage Protection

Proper power-supply sequencing is recommended for all CMOS devices. Always apply V_+ before applying analog signals, especially if the analog signal is not current-limited.

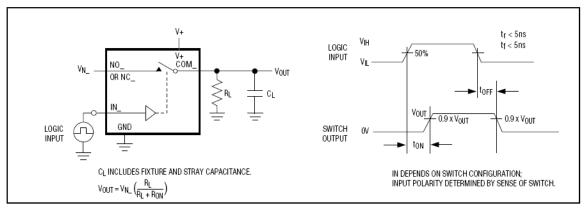


Figure 1. Switching Time

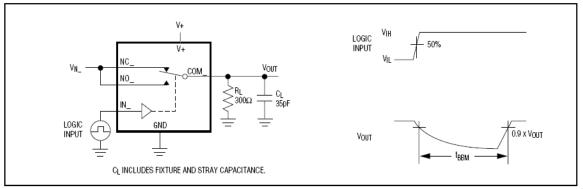


Figure 2. Break-Before-Make Interval

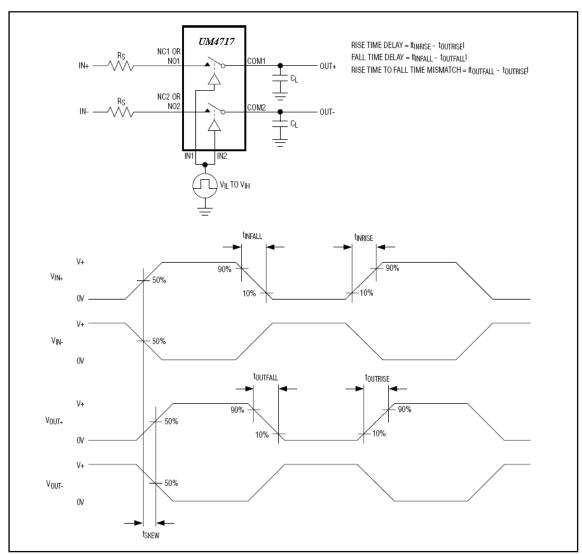


Figure 3. Output Signal Skew

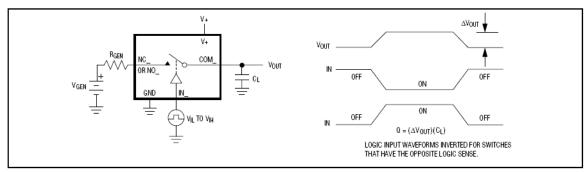


Figure 4. Charge Injection

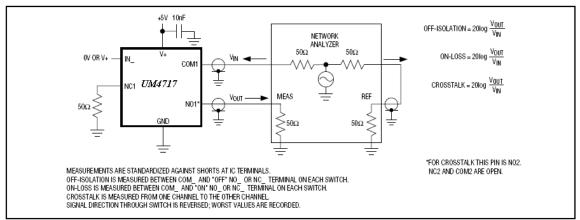


Figure 5. On-Loss, Off-Isolation, and Crosstalk

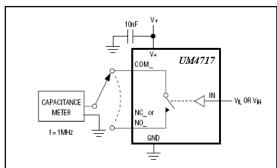
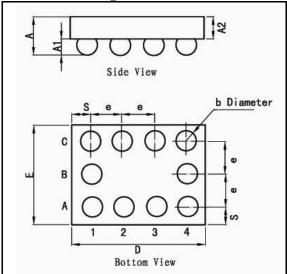


Figure 6. Channel Off/On-Capacitance

Package Information

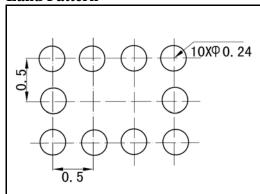
UM4717: CSP10 1.90×1.40

Outline Drawing



DIMENSIONS						
Symbol	Millir	neters	In	ch		
Symbol	Min	Max	Min	Max		
A		0.65		0.026		
A1	0.21	0.24	0.008	0.010		
A2	0.40	0.42	0.016	0.017		
b	0.27	0.32	0.011	0.013		
D	1.82	1.90	0.073	0.076		
Е	1.32	1.40	0.053	0.056		
e	0.50TYP		0.020)TYP		
S	0.15	0.17	0.006	0.007		

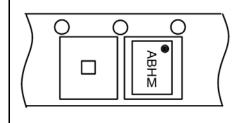
Land Pattern



NOTES:

- 1. Bump is Lead Free Sn/Ag/Cu.
- Non-solder mask defined copper landing pad.
 Laser Mark on silicon die back; back-lapped.

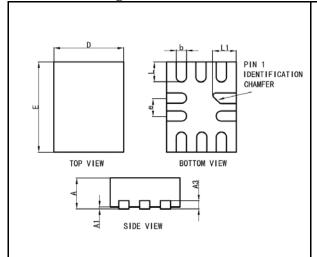
Tape and Reel Orientation



Package Information

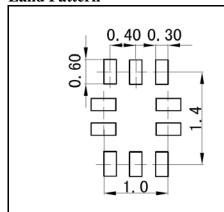
UM4717Q: WQFN-10 1.80×1.40

Outline Drawing



DIMENSIONS							
Sumbal	N	MILLIMETE	RS				
Symbol	MIN	TYP	MAX				
A	0.50	0.55	0.60				
A1	0.00	-	0.05				
A3		0.15REF					
D	1.35	1.40	1.45				
Е	1.75	1.80	1.85				
b	0.15	0.20	0.25				
L	0.30	0.40	0.50				
L1	0.40	0.50	0.60				
e		0.40BSC					

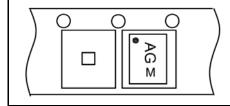
Land Pattern



NOTES:

- 1. Compound dimension: 1.40×1.80;
- 2. Unit: mm;
- 3.General tolerance ± 0.05 mm unless otherwise specified;
- 4. The layout is just for reference.

Tape and Reel Orientation





IMPORTANT NOTICE

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Union Semiconductor, Inc

Add: 7F, No. 5, Bibo Road, Shanghai 201203

Tel: 021-51097928 Fax: 021-51026018

Website: www.union-ic.com